

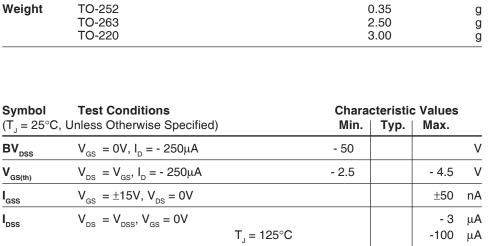
# TrenchP™ Power MOSFET

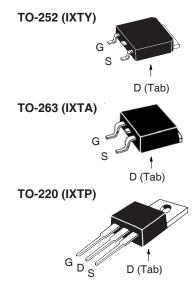
IXTY32P05T IXTA32P05T IXTP32P05T  $V_{DSS} = -50V$   $I_{D25} = -32A$   $R_{DS(on)} \le 39m\Omega$ 

P-Channel Enhancement Mode Avalanche Rated



Symbol	Test Conditions	Maximum Ratings		
V <sub>DSS</sub>	T <sub>J</sub> = 25°C to 150°C	- 50	V	
V <sub>DGR</sub>	$T_J = 25^{\circ}\text{C to } 150^{\circ}\text{C}, R_{GS} = 1\text{M}\Omega$	- 50	V	
V <sub>GSS</sub>	Continuous	<u>+</u> 15	V	
V <sub>GSM</sub>	Transient	<u>+</u> 25	V	
I <sub>D25</sub>	T <sub>C</sub> = 25°C	- 32	A	
I <sub>DM</sub>	$T_{\rm C} = 25^{\circ}$ C, Pulse Width Limited by $T_{\rm JM}$	-110	Α	
I <sub>A</sub>	T <sub>C</sub> = 25°C	- 32	A	
E <sub>AS</sub>	$T_{c} = 25^{\circ}C$	200	mJ	
$P_{D}$	T <sub>C</sub> = 25°C	83	W	
T <sub>J</sub>		-55 +150	°C	
T <sub>JM</sub>		150	°C	
T <sub>stg</sub>		-55 +150	°C	
T <sub>L</sub>	Maximum Lead Temperature for Soldering	300	°C	
T <sub>SOLD</sub>	1.6 mm (0.062in.) from Case for 10s	260	°C	
$M_d$	Mounting Torque (TO-220)	1.13 / 10	Nm/lb.in	
Weight	TO-252	0.35	g	
	TO-263	2.50	g	
	TO-220	3.00	g	





G = Gate D = DrainS = Source Tab = Drain

### **Features**

- International Standard Packages
- Avalanche Rated
- Extended FBSOA
- Fast Intrinsic Diode
- $^{ullet}$  Low  $R_{\scriptscriptstyle DS(ON)}$  and  $Q_{\scriptscriptstyle G}$

### **Advantages**

- Easy to Mount
- Space Savings
- High Power Density

## **Applications**

- High-Side Switching
- Push Pull Amplifiers
- DC Choppers

39  $m\Omega$ 

- Automatic Test Equipment
- Current Regulators
- Battery Charger Applications

 $\boldsymbol{R}_{DS(\underline{on})}$ 

 $V_{GS} = -10V$ ,  $I_{D} = 0.5 \cdot I_{D25}$ , Note 1



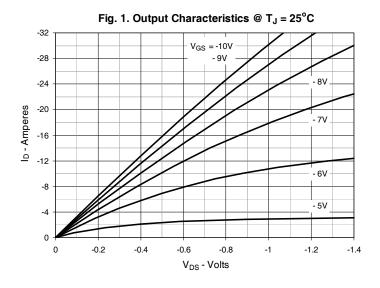
Symbol		Test Conditions	Characteristic Values			
$(1_{J} = 25)$	o°C, L	Inless Otherwise Specified)	Min.	Тур.	Max.	
g <sub>fs</sub>		$V_{DS} = -10V, I_{D} = 0.5 \bullet I_{D25}, \text{ Note 1}$	11	17	S	
C <sub>iss</sub>	}	$V_{GS} = 0V, V_{DS} = -25V, f = 1MHz$		1975	pF	
C <sub>oss</sub>				315	pF	
$\mathbf{C}_{rss}$				160	pF	
t <sub>d(on)</sub>	}	Resistive Switching Times $V_{GS} = -10V, \ V_{DS} = -30V, \ I_{D} = 0.5 \bullet I_{D25}$ $R_{G} = 10\Omega \ (External)$		20	ns	
t,				28	ns	
$\mathbf{t}_{d(off)}$				39	ns	
t <sub>f</sub>				27	ns	
Q <sub>g(on)</sub>	}			46	nC	
$\mathbf{Q}_{gs}$		$V_{GS} = -10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 \cdot I_{D25}$		19	nC	
$\mathbf{Q}_{gd}$				11	nC	
R <sub>thJC</sub>					1.5 °C/W	
$\mathbf{R}_{\mathrm{thCS}}$		TO-220		0.50	°C/W	

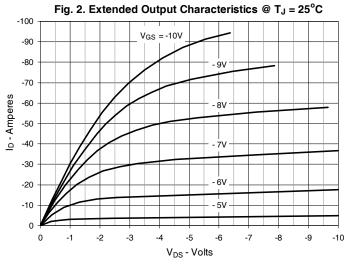
#### Source-Drain Diode

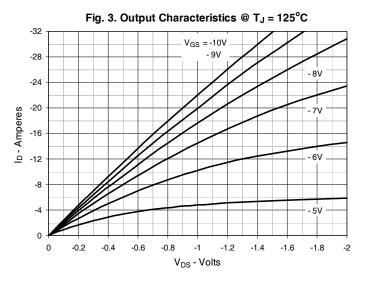
		Charac Min.	teristic Values Typ.   Max.		
I <sub>s</sub>	$V_{GS} = 0V$			- 32	A
I <sub>SM</sub>	Repetitive, Pulse Width Limited by $T_{_{\rm JM}}$			-128	Α
V <sub>SD</sub>	$I_F = I_S$ , $V_{GS} = 0V$ , Note 1			-1.5	V
t <sub>rr</sub> }	$I_F = 0.5 \cdot I_{D25}$ , -di/dt = -100A/ $\mu$ s $V_R = -25V$ , $V_{GS} = 0V$		26 21		ns nC
I <sub>RM</sub>	$V_R = -25V, V_{GS} = 0V$		-1.6		Α

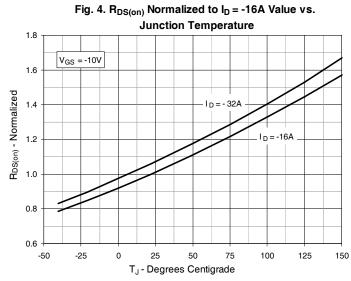
Note 1: Pulse test,  $t \le 300\mu s$ , duty cycle,  $d \le 2\%$ .

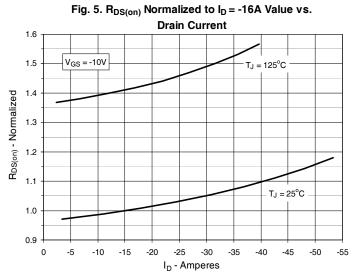


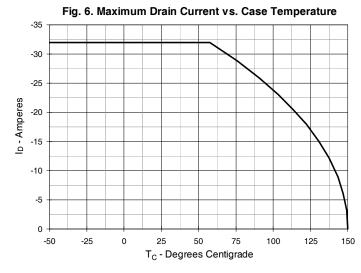




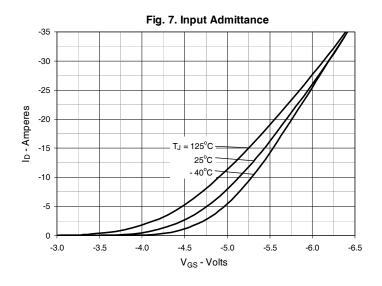


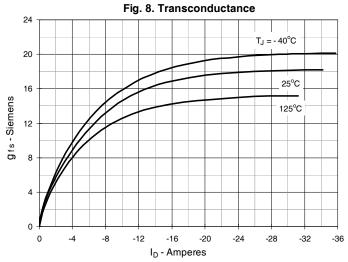


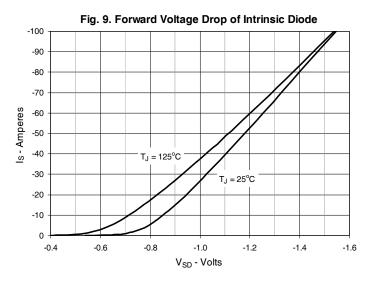


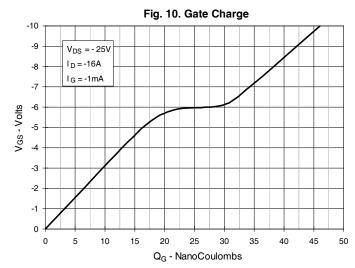


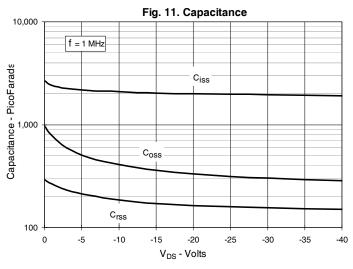


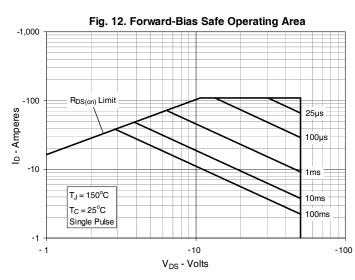






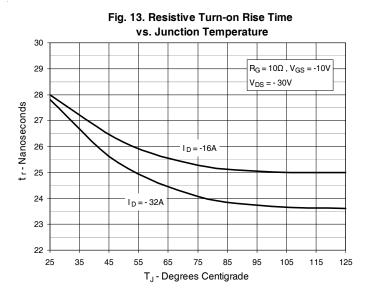


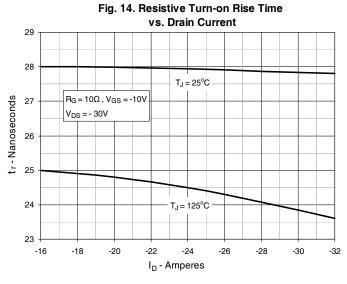


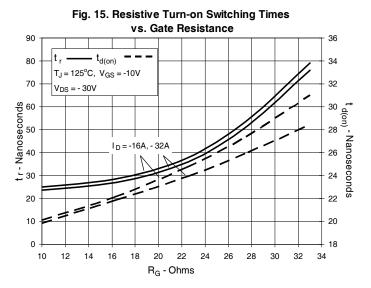


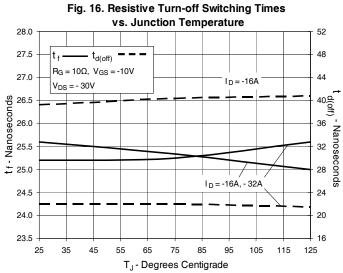
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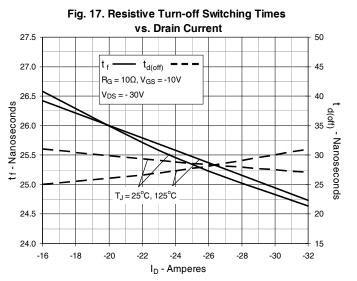


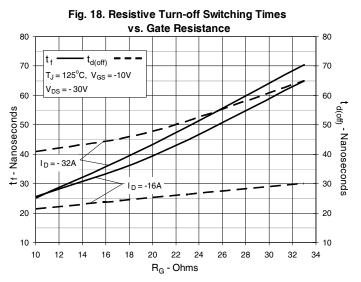




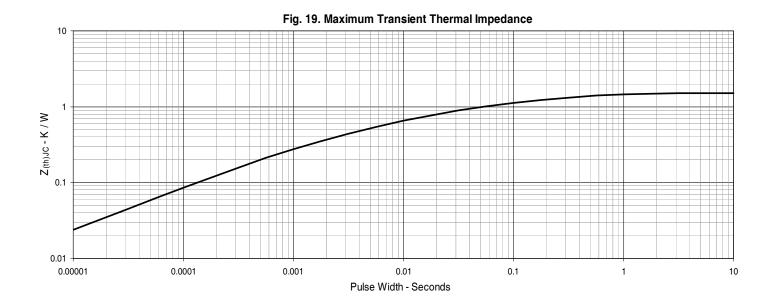


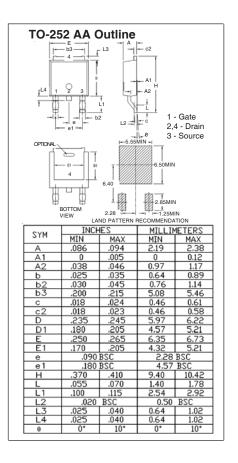


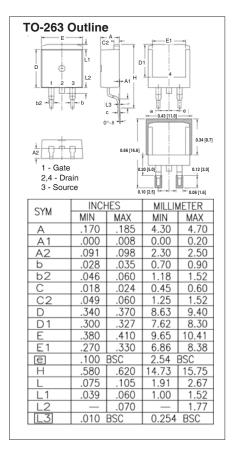


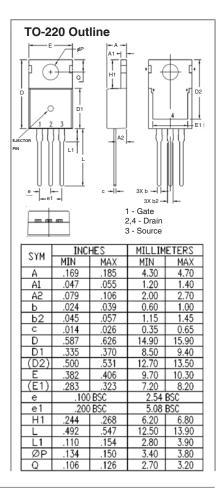












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